

BRS L1 4967 385/14.ccls. or 385/137.ccls. or 385/49.ccls. or 385/51.ccls. or
 385/99.ccls. or 385/129.ccls. or 385/130.ccls. or 385/132.ccls. USPAT; US-PGPUB
 2004/02/06 21:36 0

BRS 306 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7) USPAT; US-PGPUB 2004/02/06 21:00 0

BRS 269 (((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7)) and (optic\$6 with waveguide) USPAT; US-PGPUB
 2003/09/27 15:47 0

BRS 288 (((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7)) and optic\$6 USPAT; US-PGPUB 2003/09/27 15:47
 0

BRS 312 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7 or shak\$7) and optic\$6 USPAT; US-PGPUB 2003/09/27 15:49
 0

BRS 70 ((chip\$6 or wafer\$7) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or
 shak\$7) same (chip\$6 or wafer\$7)) USPAT; US-PGPUB 2003/09/27 15:56
 0

BRS 1 6542659.pn. USPAT; US-PGPUB 2003/09/27 18:50
 0

BRS 75 ((chip\$6 or wafer\$7 or bench\$6) with waveguide) and substrate and
 (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or
 shock\$7 or shak\$7) same (chip\$6 or wafer\$7)) USPAT; US-PGPUB 2003/09/29
 11:31 0

BRS 2 (wafer near2 (foam or resilien\$6)) and (optic\$6 with waveguide)
 USPAT; US-PGPUB 2003/09/27 17:14 0

BRS 0 20020159674.URPN. USPAT 2003/09/27 17:30
 0

BRS 1 6498880.pn. USPAT; US-PGPUB 2003/09/27 18:52
 0

BRS 1 5687287.pn. USPAT; US-PGPUB 2003/09/27 18:52
 0

BRS 1 5687267.pn. USPAT; US-PGPUB 2003/09/27 18:54
 0

BRS 1 4178713.pn. USPAT; US-PGPUB 2003/09/29 10:13
 0

BRS 169 Cylinder and cover and module and 385/\$.ccls. USPAT; US-PGPUB
 2003/09/29 10:14 0

BRS 108 Cylinder and cover and module and 385/\$.ccls. USPAT
 2003/09/29 10:31 0

BRS 50 (Cylinder and cover and module and 385/\$.ccls.) and bond\$8
 USPAT 2003/09/29 10:14 0

BRS 1055 module and cover and module and 385/\$.ccls. USPAT
 2003/09/29 10:16 0

BRS	2	mooney.xa. and cover and module and hermet\$8	USPAT	
		2003/09/29 10:18	0	
BRS	4	("5124281" "5500910" "5764836" "5835659").PN.	USPAT	
		2003/09/29 10:18	0	
BRS	8	mooney.xa. and cover and module	USPAT	2003/09/29 10:19
		0		
BRS	61	mooney.xa. and cover	USPAT	2003/09/29 10:19
		0		
BRS	41	mooney.xa. and cover and michael	USPAT	2003/09/29 10:22
		0		
BRS	10	("4808115" "5091987" "5140659" "5195904" "5302141" "5529513" "5574815" "5641306" "5743763" "5812728").PN.	USPAT	2003/09/29 10:20
		0		
BRS	10	("4738507" "4738508" "5082345" "5212752" "5274729" "5687268" "5838855" "6126325" "6283640" "6335993").PN.	USPAT	2003/09/29 10:21
		0		
BRS	15	mooney.xa. and cover and michael and substrate	USPAT	
		2003/09/29 10:31	0	
BRS	2	("5011246" "5390271").PN.	USPAT	2003/09/29 10:23
		0		
BRS	7	("4130343" "4756590" "4897711" "4981334" "5073003" "5155786" "5163113").PN.	USPAT	2003/09/29 10:23
				0
BRS	51	Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:34
				0
BRS	155	Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:37
				0
BRS	104	(Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not (Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))	USPAT	2003/09/29 10:35
				0
BRS	352	cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)	USPAT	2003/09/29 10:37
				0
BRS	197	(cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not ((Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4)) not (Cylinder and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))) not (Cylind\$9 and cover and module and 385/\$.ccls. and (hermet\$8 or seal\$4))	USPAT	2003/09/29 11:29
				0
BRS	13	5444804.URPN.	USPAT	2003/09/29 10:39
		0		
BRS	1	5214726.pn.	USPAT	2003/09/29 10:54
				0
BRS	33	gel with elastic\$6 and 385/\$.ccls.	USPAT	2003/09/29 10:55
		0		
BRS	5	5214726.URPN.	USPAT	2003/09/29 10:58
		0		
BRS	113	chip and (module or package) and damp\$6 and optic\$6 and waveguide	USPAT	2003/09/29 11:30
				0

BRS 75 ((chip\$6 or wafer\$7 or bench\$6) with waveguide) and substrate and
 (harsh\$4 or impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or
 shock\$7 or shak\$7) same (chip\$6 or wafer\$7)) USPAT; US-PGPUB 2003/09/29
 11:31 0

BRS 111 (chip and (module or package) and damp\$6 and optic\$6 and waveguide)
 not (((chip\$6 or wafer\$7 or bench\$6) with waveguide) and substrate and (harsh\$4 or
 impact\$6 or shock\$7 or shak\$7) and optic\$6 and ((harsh\$4 or impact\$6 or shock\$7 or
 shak\$7) same (chip\$6 or wafer\$7))) USPAT; US-PGPUB 2003/09/29 13:03
 0

BRS 13 5444804.URPN. USPAT 2003/09/29 12:55
 0

BRS 22 UV with curable with adhes\$6 with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:10 0

BRS 5 low with modulus with elasticity with impact with protect\$6
 USPAT; US-PGPUB 2003/09/29 13:12 0

BRS 30 modulus with elasticity with spong\$6 USPAT; US-PGPUB 2003/09/29
 13:24 0

BRS 3 modulus with elasticity with viton USPAT; US-PGPUB 2003/09/29
 13:26 0

BRS 0 N/m with "Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:27 0

BRS 5 "N/m" with \$6"Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:36 0

BRS 9 "N/m"\$6 with \$6"Pa" with modulus with elast\$8 USPAT; US-PGPUB
 2003/09/29 13:44 0

BRS 4 ("N/m"\$6 with \$6"Pa" with modulus with elast\$8) not ("N/m" with \$6"Pa"
 with modulus with elast\$8) USPAT; US-PGPUB 2003/09/29 13:39
 0

BRS 2 "N/m"\$6 with \$6"Pa" with modulus with elast\$8 same "kgf/cm.sup.2"
 USPAT; US-PGPUB 2003/09/29 14:06 0

BRS 4 5999674.URPN. USPAT 2003/09/29 13:57
 0

BRS 2 (\$6"Pa" or "kgf/cm.sup.2") with modulus with elast\$8 with UV with
 curable USPAT; US-PGPUB 2003/09/29 14:08 0

BRS 7 ("5367591" | "5426714" | "5444804" | "5481632" | "5513290" | "5625730"
 | "5696860").PN. USPAT 2003/09/29 14:24 0